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### Vishay Semiconductors

## Infrared Emitting Diode, 950 nm, GaAs



### **DESCRIPTION**

TSUS6202 is an infrared, 950 nm emitting diode in GaAs technology molded in a blue-gray tinted plastic package.

#### **FEATURES**

Package type: leaded
Package form: T-1¾

Dimensions (in mm): Ø 5
 Peak wavelength: λ<sub>p</sub> = 950 nm

High reliability

• Angle of half intensity:  $\varphi = \pm 15^{\circ}$ 

Low forward voltage

• Suitable for high pulse current operation

· Good spectral matching with Si photodetectors

 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>



· Emitter in transmissive sensors

• Emitter in reflective sensors

PRODUCT SUMMARY					
COMPONENT	I <sub>e</sub> (mW/sr)	φ (deg)	λ <sub>P</sub> (nm)	t <sub>r</sub> (ns)	
TSUS6202	30	± 15	950	800	

#### Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
TSUS6202	Bulk	MOQ: 4000 pcs, 4000 pcs/bulk	T-1¾	

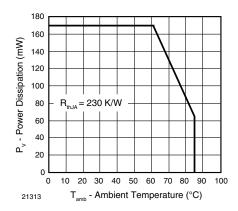
#### Note

· MOQ: minimum order quantity

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		$V_{R}$	5	V
Forward current		I <sub>F</sub>	150	mA
Peak forward current	$t_p/T = 0.5, t_p = 100 \mu s$	I <sub>FM</sub>	300	mA
Surge forward current	t <sub>p</sub> = 100 μs	I <sub>FSM</sub>	2.5	Α
Power dissipation		P <sub>V</sub>	170	mW
Junction temperature		Tj	100	°C
Operating temperature range		T <sub>amb</sub>	-40 to +85	°C
Storage temperature range		T <sub>stg</sub>	-40 to +100	°C
Soldering temperature	t ≤ 5 s, 2 mm from case	T <sub>sd</sub>	260	°C
Thermal resistance junction/ambient	J-STD-051, leads 7 mm, soldered on PCB	$R_{thJA}$	230	K/W



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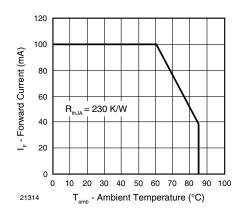


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	$V_{F}$	-	1.3	1.7	V
	$I_F = 1.5 \text{ A}, t_p = 100 \mu\text{s}$	V <sub>F</sub>	-	2.2	2.7	V
Temperature coefficient of V <sub>F</sub>	I <sub>F</sub> = 100 mA	TK <sub>VF</sub>	-	-1.3	-	mV/K
Reverse current	V <sub>R</sub> = 5 V	I <sub>R</sub>	-	-	100	μA
Junction capacitance	$V_R = 0 \text{ V, } f = 1 \text{ MHz, } E = 0$	Cj	=	30	-	pF
Radiant intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	l <sub>e</sub>	20	30	70	mW/sr
	$I_F = 1.5 \text{ A}, t_p = 100 \mu\text{s}$	l <sub>e</sub>	170	280	-	mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	фe	-	15	-	mW
Temperature coefficient of φ <sub>e</sub>	I <sub>F</sub> = 20 mA	TKφ <sub>e</sub>	-	-0.8	-	%/K
Angle of half intensity		φ	-	± 15	-	deg
Peak wavelength	I <sub>F</sub> = 100 mA	$\lambda_{p}$	-	950	-	nm
Spectral bandwidth	I <sub>F</sub> = 100 mA	Δλ	-	50	-	nm
Temperature coefficient of $\lambda_p$	I <sub>F</sub> = 100 mA	TKλ <sub>p</sub>	-	0.2	-	nm/K
Rise time	I <sub>F</sub> = 100 mA	t <sub>r</sub>	-	800	-	ns
	I <sub>F</sub> = 1.5 A	t <sub>r</sub>	-	400	-	ns
E ##	I <sub>F</sub> = 100 mA	t <sub>f</sub>	-	800	-	ns
Fall time	I <sub>F</sub> = 1.5 A	t <sub>f</sub>	-	400	-	ns
Virtual source diameter		d	-	3.8	-	mm

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### **BASIC CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

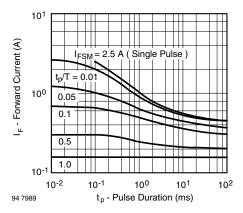


Fig. 3 - Pulse Forward Current vs. Pulse Duration

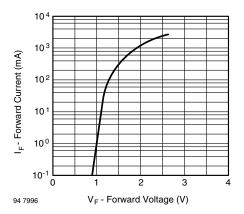


Fig. 4 - Forward Current vs. Forward Voltage

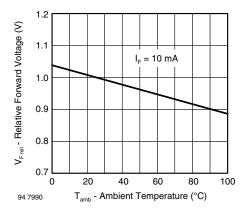


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

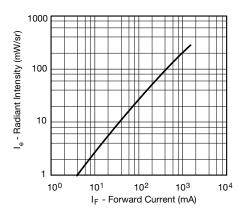


Fig. 6 - Radiant Intensity vs. Forward Current

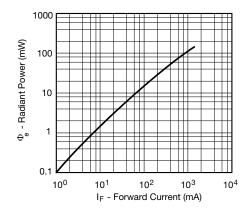


Fig. 7 - Radiant Power vs. Forward Current

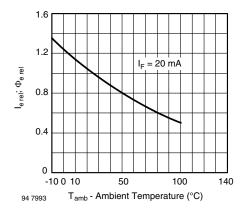


Fig. 8 - Relative Radiant Intensity/Power vs. Ambient Temperature

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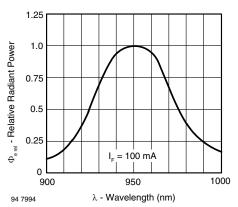


Fig. 9 - Relative Radiant Power vs. Wavelength

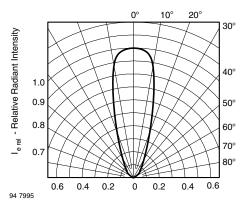
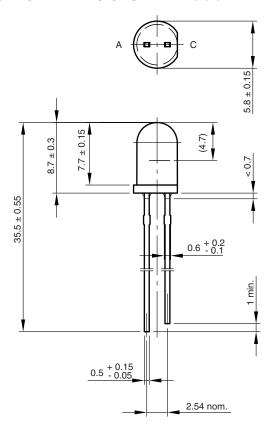
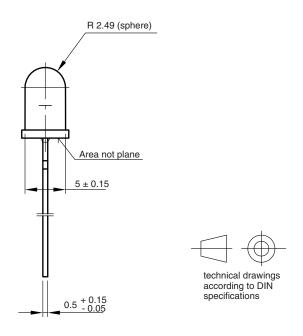


Fig. 10 - Relative Radiant Intensity vs. Angular Displacement

#### **PACKAGE DIMENSIONS** in millimeters



6.544-5259.02-4 Issue: 8; 19.05.09 95 10917





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